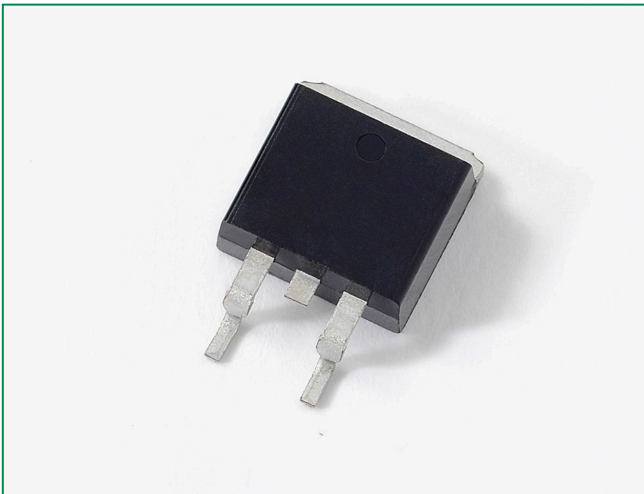


# NGB8202AN - 20 A, 400 V, N-Channel Ignition IGBT, D<sup>2</sup>PAK



20 Amps, 400 Volts  
 $V_{CE(on)} \leq 1.3 \text{ V @}$   
 $I_C = 10 \text{ A, } V_{GE} \geq 4.5 \text{ V}$

### Maximum Ratings ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

| Rating  | Symbol         | Value                  | Unit                               |
|---|----------------|------------------------|------------------------------------|
| Collector–Emitter Voltage   | $V_{CES}$      | 440                    | V                                  |
| Collector–Gate Voltage  | $V_{CER}$      | 440                    | V                                  |
| Gate–Emitter Voltage  | $V_{GE}$       | $\pm 15$               | V                                  |
| Collector Current–Continuous<br>@ $T_C = 25^\circ\text{C}$ – Pulsed                   | $I_C$          | 20<br>50               | $A_{DC}$<br>$A_{AC}$               |
| Continuous Gate Current   | $I_G$          | 1.0                    | mA                                 |
| Transient Gate Current<br>( $t \leq 2 \text{ ms, } f \leq 100 \text{ Hz}$ )           | $I_G$          | 20                     | mA                                 |
| ESD (Charged–Device Model)  | ESD            | 2.0                    | kV                                 |
| ESD (Human Body Model)<br>$R = 1500 \Omega, C = 100 \text{ pF}$                       | ESD            | 8.0                    | kV                                 |
| ESD (Machine Model)<br>$R = 0 \Omega, C = 200 \text{ pF}$                             | ESD            | 500                    | V                                  |
| Total Power Dissipation @ $T_C = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$          | 150<br>1.0             | Watts<br>$\text{W}/^\circ\text{C}$ |
| Operating and Storage<br>Temperature Range  | $T_J, T_{stg}$ | $-55 \text{ to } +175$ | $^\circ\text{C}$                   |

### Description

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

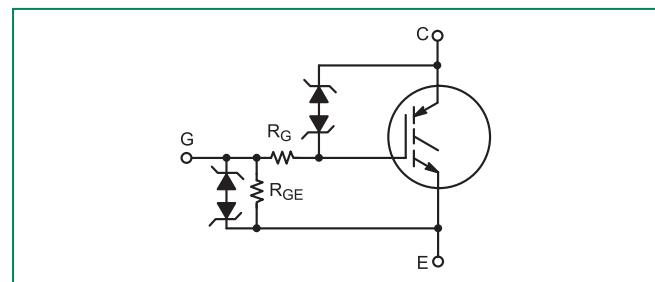
### Features

- Ideal for Coil–on–Plug and Driver–on–Coil Applications
- Gate–Emitter ESD Protection
- Temperature Compensated Gate–Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage for Interfacing Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- These are Pb–Free Devices

### Applications

- Ignition Systems

### Functional Diagram



### Additional Information



Datasheet



Resources



Samples

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Unclamped Collector–To–Emitter Avalanche Characteristics ( $-55^{\circ} \leq T_J \leq 175^{\circ}\text{C}$ )**

|  | Symbol      | Value | Unit |
|--|-------------|-------|------|
| Single Pulse Collector–to–Emitter Avalanche Energy   |             |       |      |
| $V_{CC} = 50\text{ V}, V_{GE} = 5.0\text{ V}, P_k, I_L = 16.7\text{ A}, R_G = 1000\ \Omega, L = 1.8\text{ mH}, \text{Starting } T_J = 25^{\circ}\text{C}$  | $E_{AS}$    | 250   | mJ   |
| $V_{CC} = 50\text{ V}, V_{GE} = 5.0\text{ V}, P_k, I_L = 14.9\text{ A}, R_G = 1000\ \Omega, L = 1.8\text{ mH}, \text{Starting } T_J = 150^{\circ}\text{C}$ |             | 200   |      |
| $V_{CC} = 50\text{ V}, V_{GE} = 5.0\text{ V}, P_k, I_L = 14.1\text{ A}, R_G = 1000\ \Omega, L = 1.8\text{ mH}, \text{Starting } T_J = 175^{\circ}\text{C}$ |             | 180   |      |
| Reverse Avalanche Energy   |             |       |      |
| $V_{CC} = 100\text{ V}, V_{GE} = 20\text{ V}, P_k, I_L = 25.8\text{ A}, L = 6.0\text{ mH}, \text{Starting } T_J = 25^{\circ}\text{C}$                      | $E_{AS(R)}$ | 2000  | mJ   |

**Thermal Characteristics**

|   | Symbol          | Value | Unit                        |
|---|-----------------|-------|-----------------------------|
| Thermal Resistance, Junction to Case  | $R_{\theta JC}$ | 1.0   | $^{\circ}\text{C}/\text{W}$ |
| Thermal Resistance, Junction to Ambient (Note 1)                              | $R_{\theta JA}$ | 62.5  | $^{\circ}\text{C}/\text{W}$ |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | $T_L$           | 275   | $^{\circ}\text{C}$          |

1. When surface mounted to an FR4 board using the minimum recommended pad size.

**Electrical Characteristics - OFF**

| Characteristic                            | Symbol           | Test Conditions                                     | Temperature   | Min   | Typ   | Max  | Unit          |
|---|------------------|---|---|-------|-------|------|---------------|
| Collector–Emitter Clamp Voltage           | $BV_{CES}$       | $I_C = 2.0 \text{ mA}$                              | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | 370   | 395   | 420  | V             |
|   |                  | $I_C = 10 \text{ mA}$                               | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | 390   | 415   | 440  |               |
| Zero Gate Voltage Collector Current       | $I_{CES}$        | $V_{GE} = 0 \text{ V}$ ,<br>$V_{CE} = 15 \text{ V}$ | $T_J = 25^\circ\text{C}$                            | –     | 0.1   | 1.0  | $\mu\text{A}$ |
|   |                  |   | $T_J = 175^\circ\text{C}$                           | 0.5   | 1.5   | 10   |               |
|   |                  |   | $T_J = -40^\circ\text{C}$                           | 1.0   | 25    | 100* |               |
| Reverse Collector–Emitter Clamp Voltage   | $B_{V_{CES(R)}}$ | $I_C = -75 \text{ mA}$                              | $T_J = 25^\circ\text{C}$                            | 30    | 35    | 39   | V             |
|   |                  |   | $T_J = 175^\circ\text{C}$                           | 35    | 39    | 45*  |               |
|   |                  |   | $T_J = -40^\circ\text{C}$                           | 30    | 33    | 37   |               |
| Reverse Collector–Emitter Leakage Current | $I_{CES(R)}$     | $V_{CE} = -24 \text{ V}$                            | $T_J = 25^\circ\text{C}$                            | 0.05  | 0.2   | 1.0  | mA            |
|   |                  |   | $T_J = 175^\circ\text{C}$                           | 1.0   | 8.5   | 25   |               |
|   |                  |   | $T_J = -40^\circ\text{C}$                           | 0.005 | 0.025 | 0.2  |               |
| Gate–Emitter Clamp Voltage                | $BV_{GES}$       | $I_G = \pm 5.0 \text{ mA}$                          | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | 12    | 12.5  | 14   | V             |
| Gate–Emitter Leakage Current              | $I_{GES}$        | $V_{GE} = \pm 5.0 \text{ V}$                        | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | 200   | 300   | 350* | $\mu\text{A}$ |
| Gate Resistor                             | $R_G$            | –   | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | –     | 70    | –    | $\Omega$      |
| Gate Emitter Resistor                     | $R_{GE}$         | –   | $T_J = -40^\circ\text{C}$<br>to $175^\circ\text{C}$ | 14.25 | 16    | 25   | k $\Omega$    |

**Electrical Characteristics - ON (Note 3)**

| Characteristic                               | Symbol       | Test Conditions                               | Temperature               | Min | Typ | Max  | Unit                 |
|--|--------------|---|---------------------------|-----|-----|------|----------------------|
| Gate Threshold Voltage                       | $V_{GE(th)}$ | $I_C = 1.0 \text{ mA}$ ,<br>$V_{GE} = V_{CE}$ | $T_J = 25^\circ\text{C}$  | 1.5 | 1.8 | 2.1  | V                    |
|  |              |   | $T_J = 175^\circ\text{C}$ | 0.7 | 1.0 | 1.3  |                      |
|  |              |   | $T_J = -40^\circ\text{C}$ | 1.7 | 2.0 | 2.3* |                      |
| Threshold Temperature Coefficient (Negative) | –            | –   | –                         | 4.0 | 4.6 | 5.2  | mV/ $^\circ\text{C}$ |

\*Maximum Value of Characteristic across Temperature Range.  
 3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

**Electrical Characteristics - ON (Note 4)**

| Characteristic                    | Symbol              | Test Conditions                    | Temperature         | Min  | Typ  | Max  | Unit |
|-----------------------------------|---------------------|------------------------------------|---------------------|------|------|------|------|
| Collector-to-Emitter On-Voltage   | $V_{CE(on)}$        | $I_C = 6.5 A,$<br>$V_{GE} = 3.7 V$ | $T_J = 25^\circ C$  | 0.85 | 1.03 | 1.35 | V    |
|                                   |                     |                                    | $T_J = 175^\circ C$ | 0.7  | 0.9  | 1.15 |      |
|                                   |                     |                                    | $T_J = -40^\circ C$ | 0    | 1.11 | 1.4  |      |
|                                   |                     | $I_C = 9.0 A,$<br>$V_{GE} = 3.9 V$ | $T_J = 25^\circ C$  | 0.9  | 1.11 | 1.45 |      |
|                                   |                     |                                    | $T_J = 175^\circ C$ | 0.8  | 1.01 | 1.25 |      |
|                                   |                     |                                    | $T_J = -40^\circ C$ | 1.0  | 1.18 | 1.5  |      |
|                                   |                     | $I_C = 7.5 A,$<br>$V_{GE} = 4.5 V$ | $T_J = 25^\circ C$  | 0.85 | 1.15 | 1.4  |      |
|                                   |                     |                                    | $T_J = 175^\circ C$ | 0.7  | 0.95 | 1.2  |      |
|                                   |                     |                                    | $T_J = -40^\circ C$ | 1.0  | 1.3  | 1.6* |      |
|                                   |                     | $I_C = 10 A,$<br>$V_{GE} = 4.5 V$  | $T_J = 25^\circ C$  | 1.0  | 1.3  | 1.6  |      |
|                                   |                     |                                    | $T_J = 175^\circ C$ | 0.8  | 1.05 | 1.4  |      |
|                                   |                     |                                    | $T_J = -40^\circ C$ | 1.1  | 1.4  | 1.7* |      |
|                                   |                     | $I_C = 15 A,$<br>$V_{GE} = 4.5 V$  | $T_J = 25^\circ C$  | 1.15 | 1.45 | 1.7  |      |
|                                   |                     |                                    | $T_J = 175^\circ C$ | 1.0  | 1.3  | 1.55 |      |
|                                   |                     |                                    | $T_J = -40^\circ C$ | 1.25 | 1.55 | 1.8* |      |
| $I_C = 20 A,$<br>$V_{GE} = 4.5 V$ | $T_J = 25^\circ C$  | 1.1                                | 1.4                 | 1.9  |      |      |      |
|                                   | $T_J = 175^\circ C$ | 1.2                                | 1.5                 | 1.8  |      |      |      |
|                                   | $T_J = -40^\circ C$ | 1.3                                | 1.42                | 2.0  |      |      |      |
| Forward Transconductance          | gfs                 | $V_{CE} = 5.0 V,$<br>$I_C = 6.0 A$ | $T_J = 25^\circ C$  | 10   | 18   | 25   | Mhos |

**Dynamic Characteristics**

| Characteristic       | Symbol    | Test Conditions                               | Temperature              | Min  | Typ  | Max  | Unit |
|----------------------|-----------|---|--------------------------|------|------|------|------|
| Input Capacitance    | $C_{ISS}$ | $V_{CE} = 25\text{ V}$<br>$f = 10\text{ kHz}$ | $T_J = 25^\circ\text{C}$ | 1100 | 1300 | 1500 | pF   |
| Output Capacitance   | $C_{OSS}$ |   |                          | 70   | 80   | 90   |      |
| Transfer Capacitance | $C_{RSS}$ |   |                          | 18   | 20   | 22   |      |

**Switching Characteristics**

| Characteristic                     | Symbol       | Test Conditions  | Temperature               | Min | Typ  | Max | Unit |
|------------------------------------|--------------|--|---------------------------|-----|------|-----|------|
| Turn-Off Delay Time<br>(Resistive) | $t_{d(off)}$ | $V_{CC} = 300\text{ V}$ ,<br>$I_C = 9\text{ A}$ ,<br>$R_G = 1.0\text{ k}\Omega$ ,<br>$R_L = 33\ \Omega$ ,<br>$V_{GE} = 5.0\text{ V}$ | $T_J = 25^\circ\text{C}$  | 6.0 | 8.0  | 10  | μSec |
|                                    |              |  | $T_J = 175^\circ\text{C}$ | 6.0 | 8.0  | 10  |      |
| Fall Time<br>(Resistive)           | $t_f$        |  | $T_J = 25^\circ\text{C}$  | 4.0 | 6.0  | 8.0 |      |
|                                    |              |  | $T_J = 175^\circ\text{C}$ | 8.0 | 10.5 | 14  |      |
| Turn-Off Delay Time<br>(Inductive) | $t_{d(off)}$ |  | $T_J = 25^\circ\text{C}$  | 3.0 | 5.0  | 7.0 |      |
|                                    |              |  | $T_J = 175^\circ\text{C}$ | 5.0 | 7.0  | 9.0 |      |
| Fall Time<br>(Inductive)           | $t_f$        |  | $T_J = 25^\circ\text{C}$  | 1.5 | 3.0  | 4.5 |      |
|                                    |              |  | $T_J = 175^\circ\text{C}$ | 5.0 | 7.0  | 10  |      |
| Turn-On Delay Time                 | $t_{d(on)}$  | $T_J = 25^\circ\text{C}$   | 1.0                       | 1.5 | 2.0  |     |      |
|                                    |              | $T_J = 175^\circ\text{C}$  | 1.0                       | 1.5 | 2.0  |     |      |
| Rise Time                          | $t_r$        | $T_J = 25^\circ\text{C}$   | 4.0                       | 6.0 | 8.0  |     |      |
|                                    |              | $T_J = 175^\circ\text{C}$  | 3.0                       | 5.0 | 7.0  |     |      |

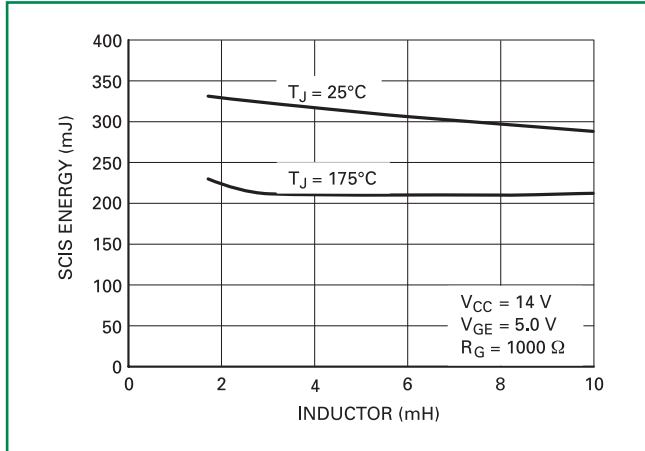
4. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

\*Maximum Value of Characteristic across Temperature Range.

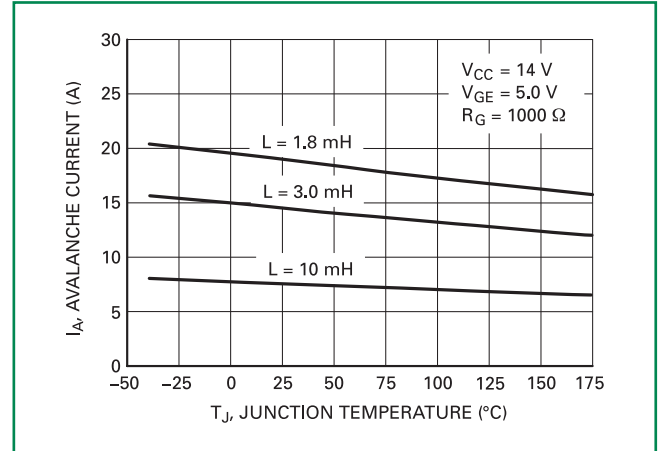
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

**Ratings and Characteristic Curves**

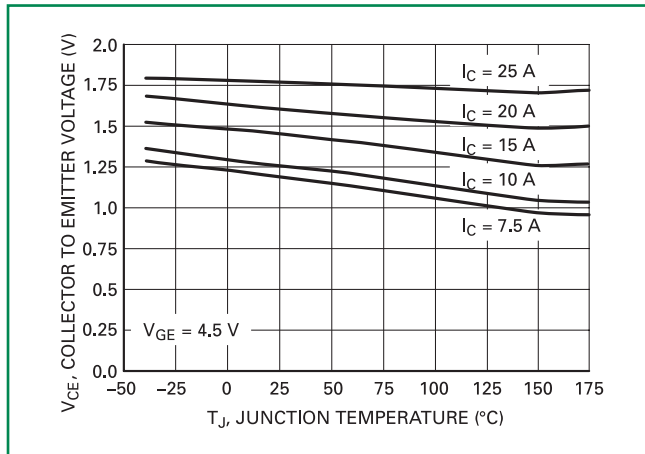
**Figure 1. Self Clamped Inductive Switching**



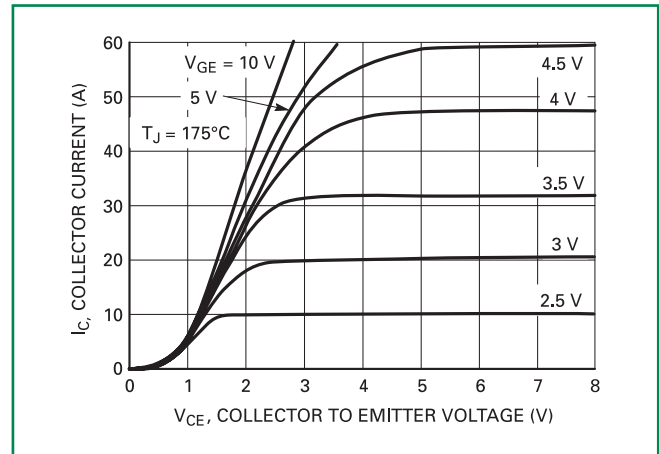
**Figure 2. Open Secondary Avalanche Current vs. Temperature**



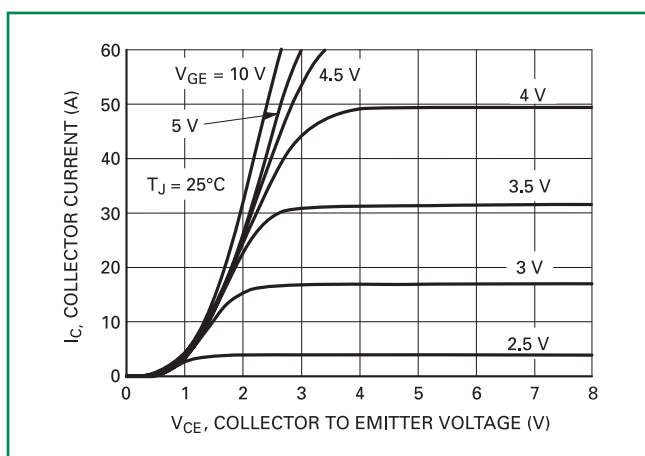
**Figure 3. Collector-to-Emitter Voltage vs. Junction Temperature**



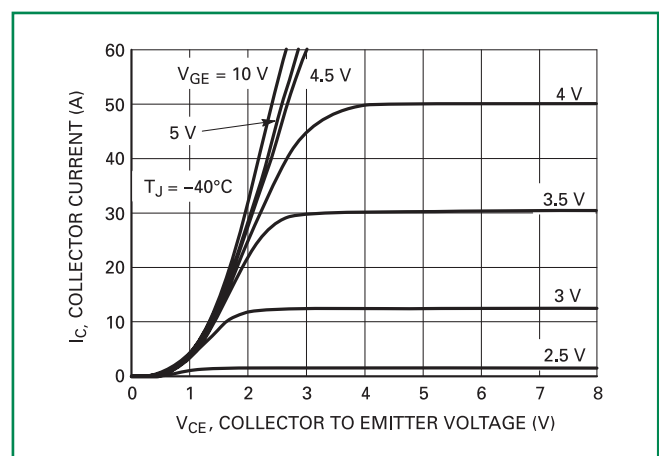
**Figure 4. Collector Current vs. Collector-to-Emitter Voltage**



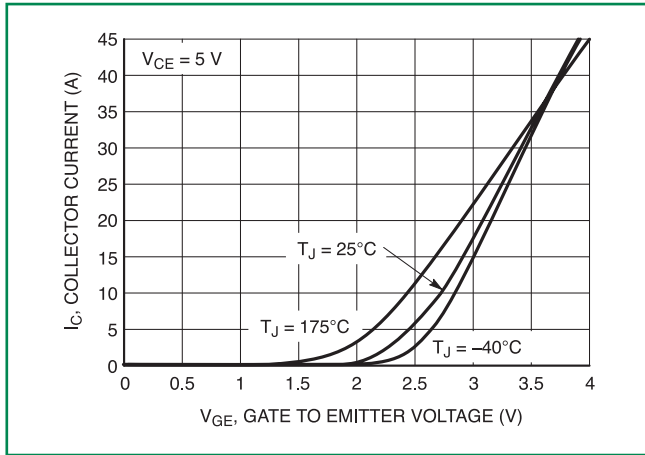
**Figure 5. Collector Current vs. Collector-to-Emitter Voltage**



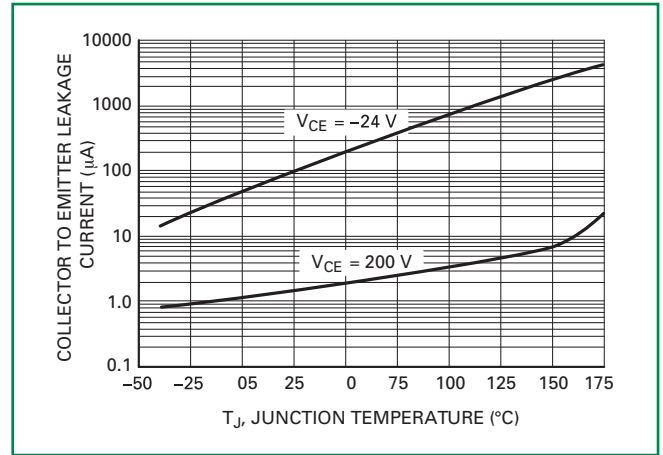
**Figure 6. Collector Current vs. Collector-to-Emitter Voltage**



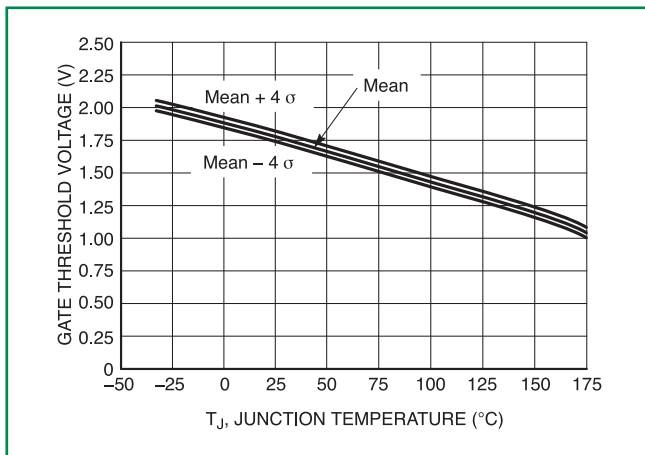
**Figure 7. Transfer Characteristics**



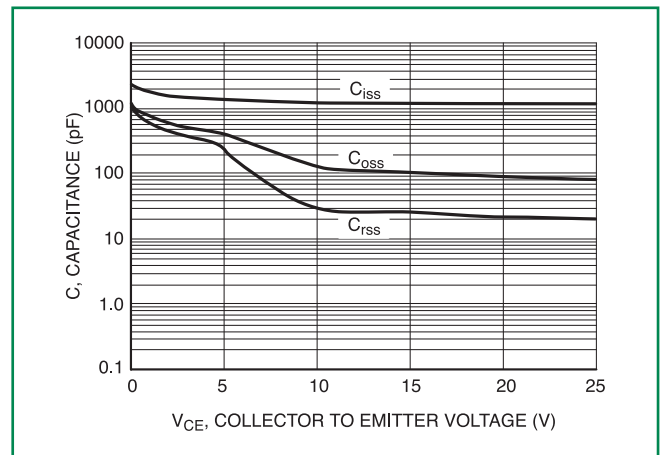
**Figure 8. Collector-to-Emitter Leakage Current vs. Temperature**



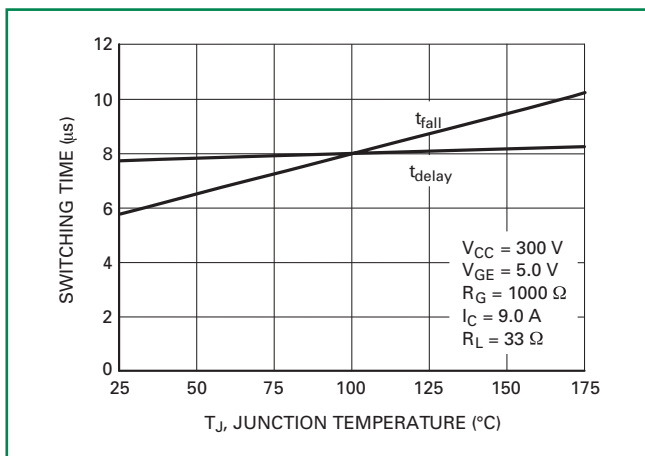
**Figure 9. Gate Threshold Voltage vs. Temperature**



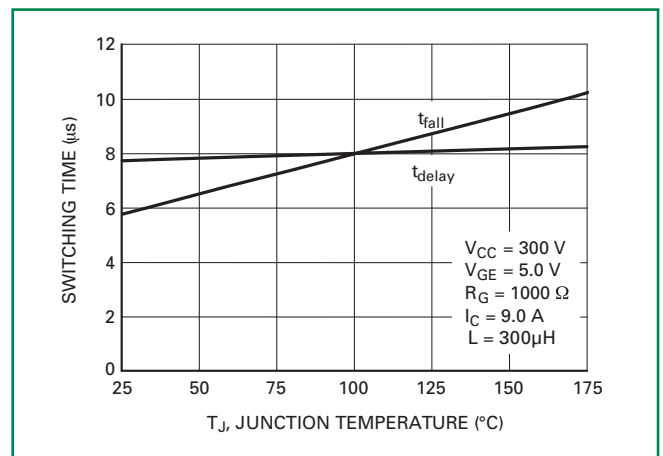
**Figure 10. Capacitance vs. Collector-to-Emitter Voltage**



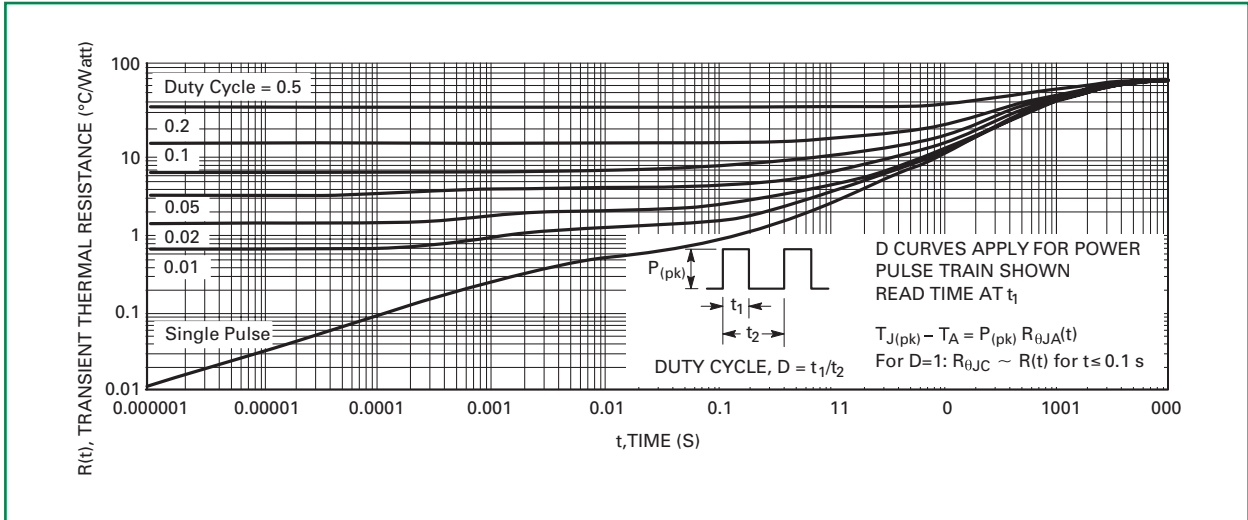
**Figure 11. Resistive Switching Fall Time vs. Temperature**



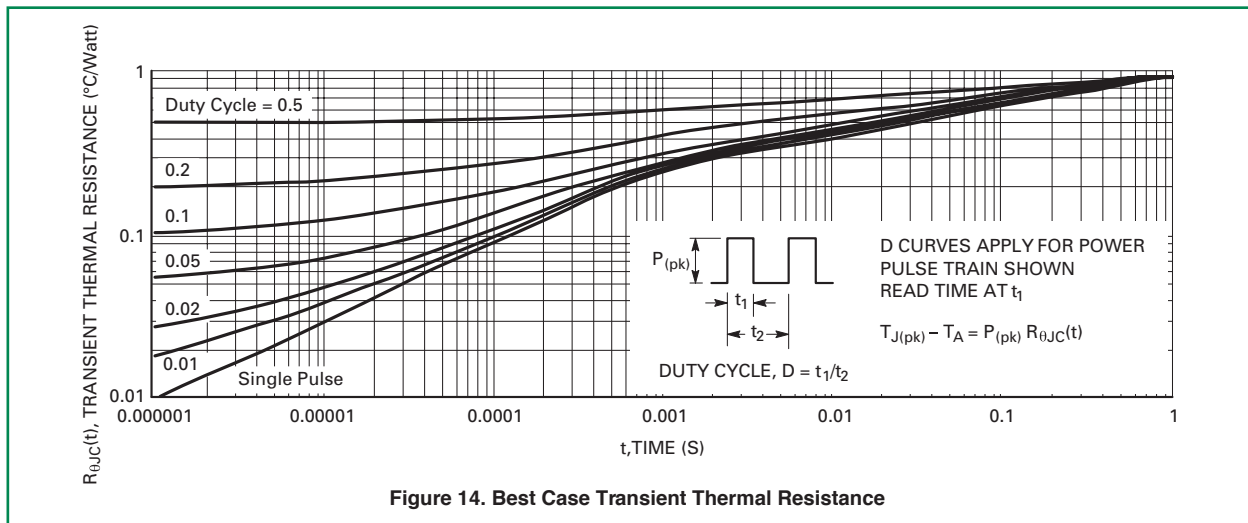
**Figure 12. Inductive Switching Fall Time vs. Temperature**



**Figure 13. Minimum Pad Transient Thermal Resistance (Non-normalized Junction-to-Ambient)**



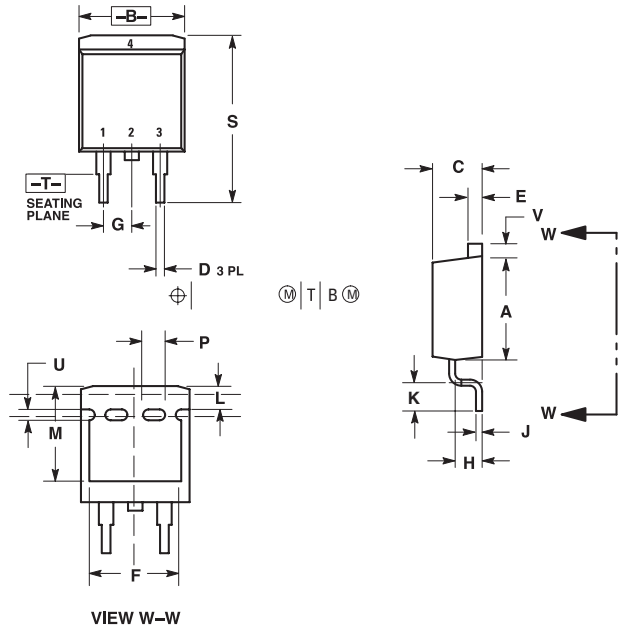
**Figure 14. Best Case Transient Thermal Resistance (Non-normalized Junction-to-Case Mounted on Cold Plate)**



**Figure 14. Best Case Transient Thermal Resistance**



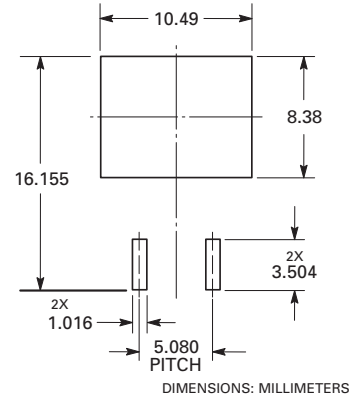
**Dimensions**



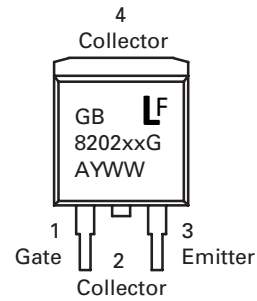
| Dim | Inches    |       | Millimeters |       |
|-----|-----------|-------|-------------|-------|
|     | Min       | Max   | Min         | Max   |
| A   | 0.340     | 0.380 | 8.64        | 9.65  |
| B   | 0.380     | 0.405 | 9.65        | 10.29 |
| C   | 0.160     | 0.190 | 4.06        | 4.83  |
| D   | 0.020     | 0.035 | 0.51        | 0.89  |
| E   | 0.045     | 0.055 | 1.14        | 1.40  |
| F   | 0.310     | 0.350 | 7.87        | 8.89  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.080     | 0.110 | 2.03        | 2.79  |
| J   | 0.018     | 0.025 | 0.46        | 0.64  |
| K   | 0.090     | 0.110 | 2.29        | 2.79  |
| L   | 0.052     | 0.072 | 1.32        | 1.83  |
| M   | 0.280     | 0.320 | 7.11        | 8.13  |
| N   | 0.197 REF |       | 5.00 REF    |       |
| P   | 0.079 REF |       | 2.00 REF    |       |
| R   | 0.039 REF |       | 0.99 REF    |       |
| S   | 0.575     | 0.625 | 14.60       | 15.88 |
| V   | 0.045     | 0.055 | 1.14        | 1.40  |

- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

**Soldering Footprint**



**Part Marking System**



GB8202xx = Device Code  
xx = AN  
A = Assembly Location  
Y = Year  
WW = Work Week  
G = Pb-Free Package

**ORDERING INFORMATION**

| Device        | Package            | Shipping             |
|---------------|--------------------|----------------------|
| NGB8202ANT4G  | D2PAK<br>(Pb-Free) | 800 /<br>Tape & Reel |
| NGB8202ANTF4G |                    | 700 /<br>Tape & Reel |

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